

COMPLIANT HALOGEN

FREE



Dual P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
- 20	$0.054 \text{ at V}_{GS} = -4.5 \text{ V}$	- 4.5 ^a		
	0.070 at V _{GS} = - 2.5 V	- 4.5 ^a	9.5 nC	
	0.104 at V _{GS} = - 1.8 V	- 4.5 ^a	9.5110	
	0.165 at V _{GS} = - 1.5 V	- 1.5		

PowerPAK SC-70-6 Dual

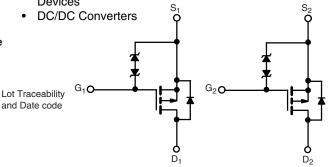
2.05 mm

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- Typical ESD Protection: 2500 V
- 100 % R_q Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Charger Switches and Load Switches for Portable Devices



Ordering Information: SiA923EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

2.05 mm

P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	S T _A = 25 °C, unle	ss otherwise no	oted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V_{DS}	- 20	V		
Gate-Source Voltage	V_{GS}	± 8	7 v		
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$. I _D -	- 4.5 ^a - 4.5 ^a - 4.5 ^a - 4.5 ^{a, b, c} - 4.5 ^{a, b, c}	A	
Pulsed Drain Current		I _{DM} - 15			
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I _S	- 4.5 ^a - 1.6 ^{b, c}	7	
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P _D	7.8 5 1.9 ^{b, c} 1.2 ^{b, c}	W	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature	, and the second	260			

Marking Code

 $X \times X$

Part # code

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16	O/ VV	

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See solder profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 110 °C/W.

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SiA923EDJ

Vishay Siliconix



SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static	1 v	V 0.V I 050 A		I	I	I .,		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V		
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = - 250 μA		- 15		mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.5				
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.5		- 1.4	V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$		± 0.3	± 3	μΑ		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$		± 3	± 30			
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1			
	Doo	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 15			Α		
		V _{GS} = - 4.5 V, I _D = - 3.8 A		0.044	0.054			
Drain-Source On-State Resistance ^a	B	V _{GS} = - 2.5 V, I _D = - 3.3 A		0.057	0.070	1		
	R _{DS(on)}	V _{GS} = - 1.8 V, I _D = - 1 A		0.075	0.104	Ω		
		V _{GS} = - 1.5 V, I _D = - 0.5 A		0.097	0.165			
Forward Transconductancea	9 _{fs}	V _{DS} = - 10 V, I _D = - 3.8 A		11		S		
Dynamic ^b					l			
·	Qg	V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 4.9 A		16.3	25	nC		
Total Gate Charge		V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 4.9 A		9.5	14.5			
Gate-Source Charge	Q _{gs}			1.4				
Gate-Drain Charge	Q _{gd}			2.3				
Gate Resistance	R _g	f = 1 MHz	1	5.1	10	Ω		
Turn-On Delay Time	t _{d(on)}			15	25	ns		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 2.6 \Omega$		16	25			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -3.9 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		30	45			
Fall Time	t _f	-		10	15			
Turn-On Delay Time	t _{d(on)}			7	15			
Rise Time	t _r	V_{DD} = - 10 V, R_{L} = 2.6 Ω		12	20			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -3.9 \text{ A, V}_{GEN} = -8 \text{ V, R}_q = 1 \Omega$		26	40			
Fall Time	t _f	<u>~ ~ ~ </u>		10	15			
Drain-Source Body Diode Characterist								
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.5			
Pulse Diode Forward Current	I _{SM}	, , ,			- 15	Α		
Body Diode Voltage	V _{SD}	I _S = - 3.9 A, V _{GS} = 0 V		- 0.9	- 1.2	V		
Body Diode Reverse Recovery Time	t _{rr}	<i>y</i> 43 -		13	25	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	1		5.5	12	nC		
Reverse Recovery Fall Time	t _a	$I_F = -3.9 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		7.5	1.2	1.10		
Reverse Recovery Rise Time t _b		1		5.5		ns		
				5.5				

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

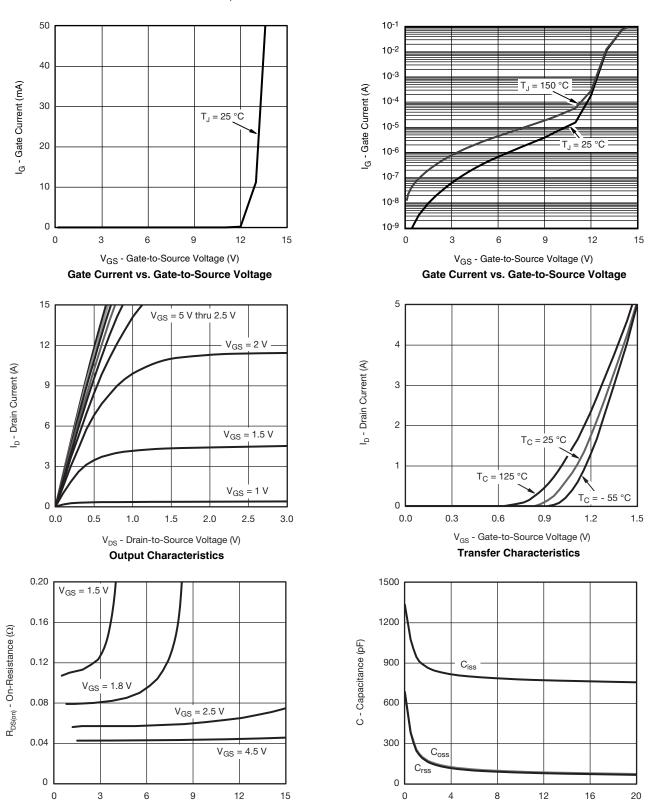
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



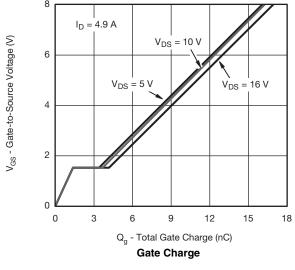
 ${\rm I_D}$ - Drain Current (A) On-Resistance vs. Drain Current and Gate Voltage V_{DS} - Drain-to-Source Voltage (V)

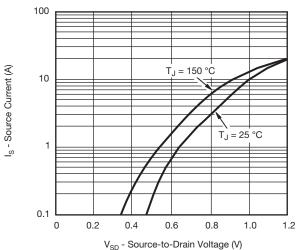
Capacitance

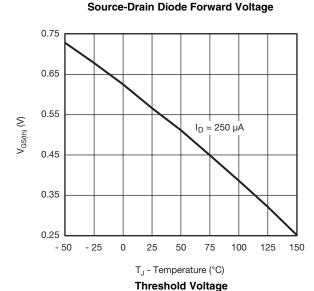
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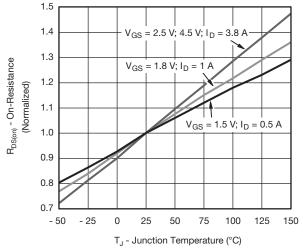
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

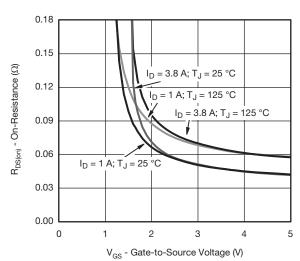




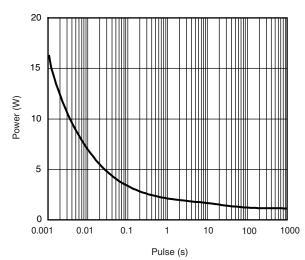








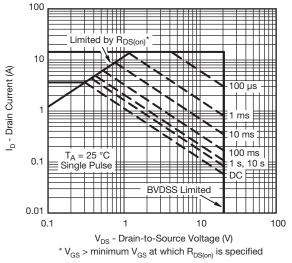
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

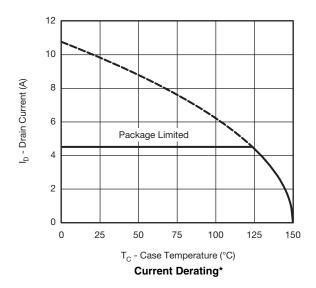


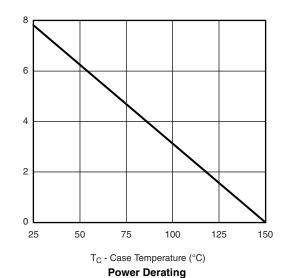
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Safe Operating Area, Junction-to-Ambient

Power Dissipation (W)



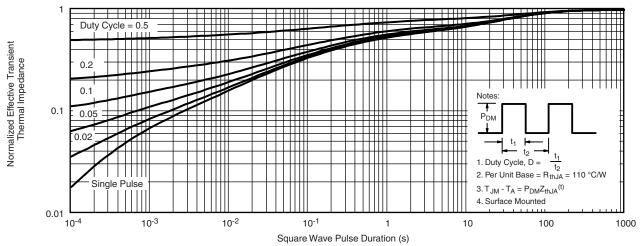


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

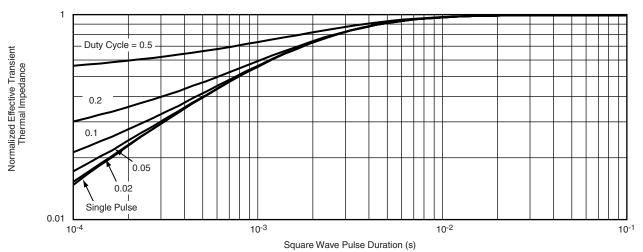
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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